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U.S. Patent & Trademark Office; U.S. DEPARTMENT OF COMMERCE

**REISSUE APPLICATION DECLARATION BY THE
INVENTOR**

Docket Number (optional),
650.00698

As below named inventors, we hereby declare that:

Our residences, mailing addresses and citizenships are stated below next to our names.

We believe we are the original, first and joint inventors (if plural names are listed below) of the subject matter which is described and claimed in patent number 5,948,850, granted September 7, 1999, and for which a reissue patent is sought on the invention entitled THERMOPLASTIC ELASTOMER COMPOSITION FOR POWDER SLUSH MOLDING AND PROCESS FOR PREPARATION OF SAID COMPOSITION, the specification of which:

☐ is attached hereto.

☒ was filed on March 22, 2001 as reissue application number 09/815,414 and was amended on June 18, 2001 and as attached hereto (if applicable).

We have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

We verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.)

☒ by reason of a defective specification or drawing.

☒ by reason of the patentee claiming more or less than he had the right to claim in the patent.

☒ by reason of other errors.

At least one error upon which reissue is based is described below. If the reissue is a broadening reissue, such must be stated with an explanation as to the nature of the broadening.

We believe that the subject matter disclosed in the specification was not claimed as broadly as we were entitled to claim. Specifically, the elastomer excellent in oil absorbing power "ethylene/octene copolymer" as recited at column 2, line 16 and column 3, lines 60-61 was not claimed in claims 1, 12, 13, 14, and 21.

We believe that we were entitled to claim ethylene/octane copolymer as an elastomer excellent in oil absorbing power in claims 1, 12, 13, 14, and 21.

New claim 27, and new claims 28-37 which depend on new claim 27; new claim 38; new claim 39; new claim 40 and new claims 48 and new claim 49 which depend on new claim 47; overcome the defect described in paragraph 7 by reciting "ethylene/octene copolymer" as an elastomer excellent in oil absorbing power.

Claims 27-49 have accordingly been submitted herewith to provide coverage commensurate in scope our invention.

Applicants hereby claim priority of Japanese Appln. No. 8-168259, filed June 6, 1996; and Japanese Appln. No. 8-299617, filed October 23, 1996.

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(Reissue Application Declaration by The Inventor, page 2)			Docket Number (optional) 650.00698		
<p>All errors corrected in this reissue application arose without any deceptive invention on the part of the applicant. As a named inventor, I hereby appoint the following attorney(s) and/or agents to prosecute this application and transact all business in the United States Patent and Trademark Office connected therewith.</p>					
Clark, Jeffrey L.	Reg. No. 29,141	Monco, Dean A	Reg. No. 30,091		
Fairchild, Jeffrey N.	Reg. No. 37,285	Mortimer, John S.	Reg. No. 30,407		
Geimer, Stephen D.	Reg. No. 28,846	Mueller, Lisa V.	Reg. No. 38,978		
Hoover, Allen J.	Reg. No. 24,103	Odell, Paul M.	Reg. No. 28,332		
Katz, Martin L.	Reg. No. 25,011	Phillips, Richard S.	Reg. No. 17,314		
McLaughlin, F. William	Reg. No. 32,273	Siegel, Joel E.	Reg. No. 25,440		
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<p>I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this declaration is directed.</p>					
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